

## 60V N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ◇ Advanced Trench cell design
- ◇ Low Gate Charge
- ◇ Low On-Resistance
- ◇ RoHS and Halogen-Free Compliant
- ◇ 100%  $\Delta V_{DS}$  & UIS & Rg Tested

#### 1.2 Applications

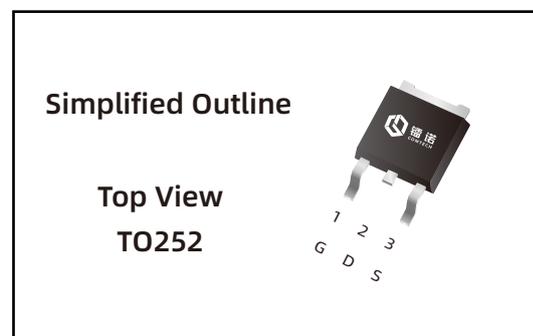
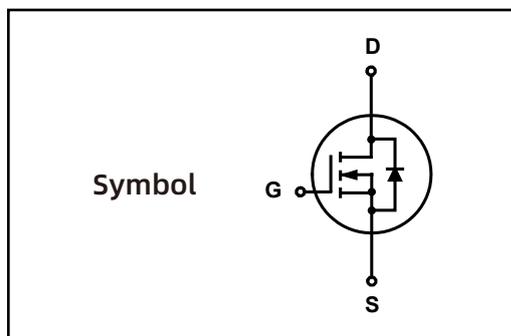
- ◇ DC-DC Converter
- ◇ Drones
- ◇ Motor drivers
- ◇ Light electric vehicles

#### 1.3 Quick reference

- ◇  $BV \cong 60\text{ V}$
- ◇  $P_{\text{tot}} \cong 112\text{ W}$
- ◇  $I_D \cong 60\text{ A}$
- ◇  $R_{DS(\text{ON})} \cong 22\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ◇  $R_{DS(\text{ON})} \cong 29\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$



### 2. Pin Description



### 3.Limiting Values

| Symbol               | Parameter                      | Conditions  | Min | Max      | Unit             | Note   |
|----------------------|--------------------------------|---|-----|----------|------------------|--------|
| $V_{DS}$             | Drain-Source Voltage           | $T_C = 25\text{ }^\circ\text{C}$                        | -   | 60       | V                | -      |
| $V_{GS}$             | Gate-Source Voltage            | $T_C = 25\text{ }^\circ\text{C}$                        | -   | $\pm 20$ | V                | -      |
| $I_D^*$              | Drain Current ( DC )           | $T_C = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$  | -   | 60       | A                | Fig.2  |
|                      |                                | $T_C = 100\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$ | -   | 38       | A                |        |
| $I_{DM}^{**},^{***}$ | Drain Current ( Pulsed )       | $T_C = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$  | -   | 153      | A                | -      |
| $P_{tot}$            | Drain power dissipation        | $T_C = 25\text{ }^\circ\text{C}$                        | -   | 112      | W                | Fig.1  |
|                      |                                | $T_C = 100\text{ }^\circ\text{C}$                       | -   | 45       | W                |        |
| $T_{stg}$            | Storage Temperature            |   | -55 | 150      | $^\circ\text{C}$ | -      |
| $T_J$                | Junction Temperature           |   | -   | 150      | $^\circ\text{C}$ | -      |
| $I_S$                | Continuous-Source Current      | $T_C = 25\text{ }^\circ\text{C}$                        | -   | 60       | A                | -      |
| $E_{AS}^*$           | Single Pulsed Avalanche Energy | $V_{DD} = 60\text{ V}, L = 0.1\text{ mH}$               | -   | 24       | mJ               | Fig.19 |

### 4.Thermal Characteristics

|                   |   |   |     |                           |        |
|-------------------|---|---|-----|---------------------------|--------|
| $R_{\theta JA}^*$ | Thermal Resistance- Junction to Ambient | - | 39  | $^\circ\text{C}/\text{W}$ | Fig.16 |
| $R_{\theta JC}^*$ | Thermal Resistance- Junction to Case    | - | 1.1 |                           |        |

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$

\*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$

\*\*\* limited by bonding wire

### 5.Marking Information

| Product Name | Package | Reel size | Tape width | Quantity | Note |
|--------------|---------|-----------|------------|----------|------|
| LN195N060J   | TO252   | 330mm     | 16mm       | 2500     |      |

Note: COMTECH defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

| Symbol   | Parameter                      | Conditions  | Min | Typ   | Max       | Unit          | Note   |
|--|--------------------------------|---|-----|-------|-----------|---------------|--------|
| <b>Static Characteristics</b>                  |                                |   |     |       |           |               |        |
| $BV_{DSS}$                                     | Drain-Source Breakdown Voltage | $V_{GS} = 0\text{ V}, I_{DS} = 250\ \mu\text{A}$  | 60  | -     | -         | V             |        |
| $V_{GS(th)}$                                   | Gate Threshold Voltage         | $V_{DS} = V_{GS}, I_{DS} = 250\ \mu\text{A}$  | 1   | -     | 3         | V             |        |
| $I_{DSS}$                                      | Drain Leakage Current          | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$   | -   | -     | 1         | $\mu\text{A}$ |        |
| $I_{GSS}$                                      | Gate Leakage Current           | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$   | -   | -     | $\pm 100$ | nA            |        |
| $R_{DS(on)}^a$                                 | On-State Resistance            | $V_{GS} = 10\text{ V}, I_{DS} = 30\text{ A}$  | -   | 20    | 22        | m $\Omega$    | Fig.8  |
|  |                                | $V_{GS} = 4.5\text{ V}, I_{DS} = 20\text{ A}$   | -   | 24    | 29        |               |        |
| <b>Diode Characteristics</b>                   |                                |   |     |       |           |               |        |
| $V_{SD}^a$                                     | Diode Forward Voltage          | $I_{SD} = 30\text{ A}, V_{GS} = 0\text{ V}$   | -   | -     | 1.3       | V             | Fig.7  |
| $t_{rr}$                                       | Reverse Recovery Time          | $I_{DS} = 30\text{ A}, V_{GS} = 0\text{ V}$   | -   | 12    | -         | nS            | Fig.20 |
| $Q_{rr}$                                       | Reverse Recovery Charge        | $dI_{SD}/dt = 100\text{ A}/\mu\text{s}$   | -   | 3     | -         | nC            |        |
| <b>Dynamic Characteristics<sup>b</sup></b>     |                                |   |     |       |           |               |        |
| $C_{ISS}$                                      | Input Capacitance              | $V_{GS} = 0\text{ V}, V_{DS} = 30\text{ V}$<br>Frequency = 1 MHz  | -   | 1522  | -         | pF            | Fig.10 |
| $C_{OSS}$                                      | Output Capacitance             |   | -   | 62    | -         |               |        |
| $C_{rSS}$                                      | Reverse Transfer Capacitance   |   | -   | 49    | -         |               |        |
| $R_G$  | Gate Resistance                | F= 1 MHz  | -   | 4.4   | -         | $\Omega$      |        |
| $t_d(on)$                                      | Turn-on Delay Time             | $V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V},$<br>$R_G=2.8\ \Omega, R_L = 8\ \mu\text{H},$<br>$I_{DS} = 30\text{ A}$ | -   | 64    | -         | nS            | Fig.18 |
| $t_r$  | Turn-on Rise Time              |   | -   | 134   | -         |               |        |
| $t_d(off)$                                     | Turn-off Delay Time            |   | -   | 138   | -         |               |        |
| $t_f$  | Turn-off Fall Time             |   | -   | 29    | -         |               |        |
| $dv/dt$  | Peak Diode Recovery            |   | -   | 0.179 | -         |               |        |
| $di/dt$  | Peak Diode Recovery            | -   | 333 | -     | A/us      |               |        |
| <b>Gate Charge Characteristics<sup>b</sup></b> |                                |   |     |       |           |               |        |
| $Q_g$  | Total Gate Charge              | $V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V},$<br>$I_{DS} = 30\text{ A}$   | -   | 27    | -         | nC            | Fig.9  |
| $Q_{gs}$                                       | Gate-Source Charge             |   | -   | 4     | -         |               |        |
| $Q_{gd}$                                       | Gate-Drain Charge              |   | -   | 10    | -         |               |        |
| $V_{plateau}$                                  | Gate plateau voltage           |   | -   | 3.4   | -         |               |        |

Notes :

a : Pulse test ; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ 

b : Guaranteed by design, not subject to production testing

## 7. Typical Characteristics

Fig.1 Power Capability

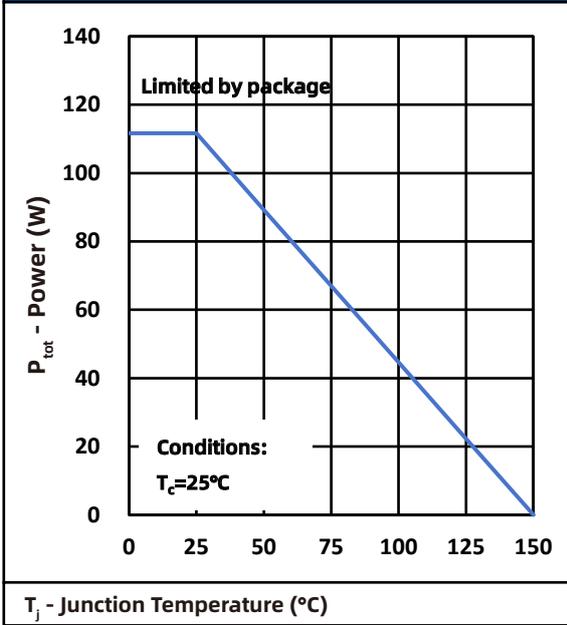


Fig.2 Current Capability

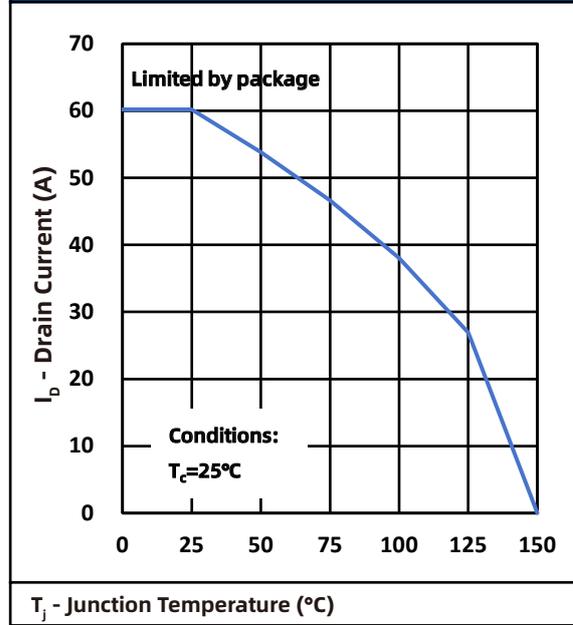


Fig.3 Output Characteristics@ $T_j = -55^\circ\text{C}$

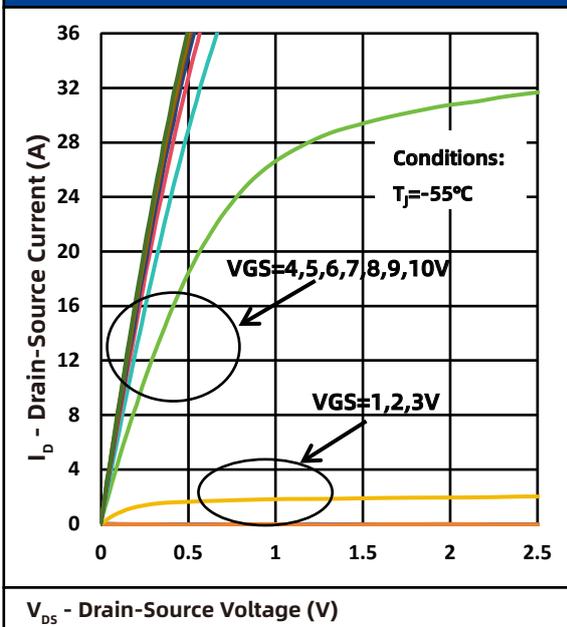
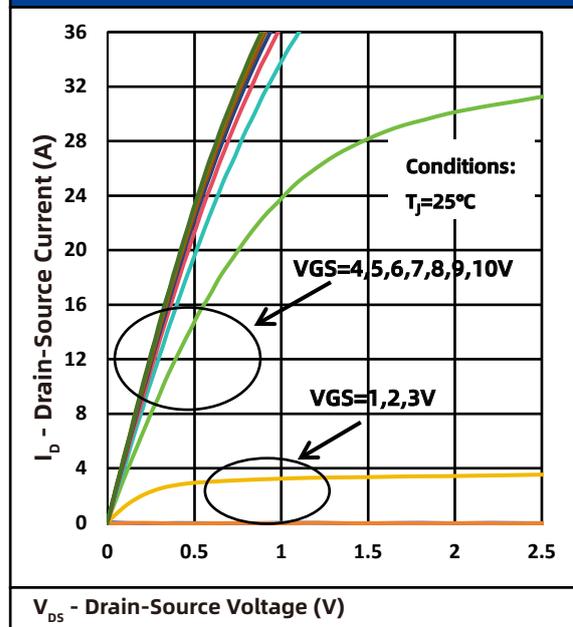


Fig.4 Output Characteristics@ $T_j = 25^\circ\text{C}$



## 7. Typical Characteristics

Fig.5 Output Characteristics@Tj 150°C

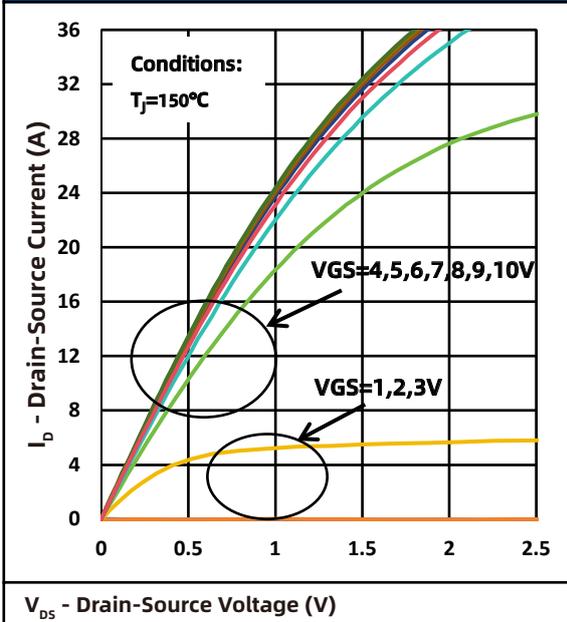


Fig.6 Transfer Characteristics vs Temp

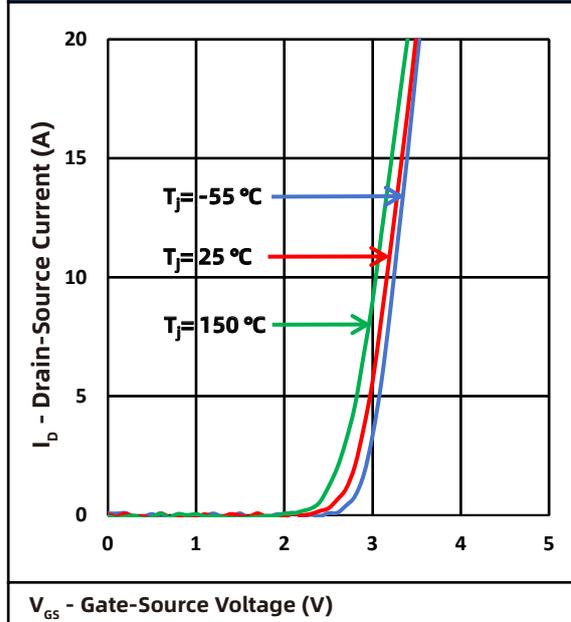


Fig.7 Body Diode Characteristics

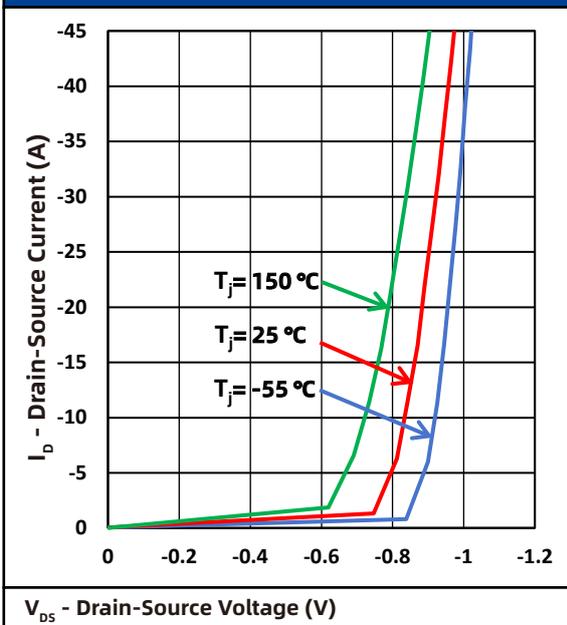
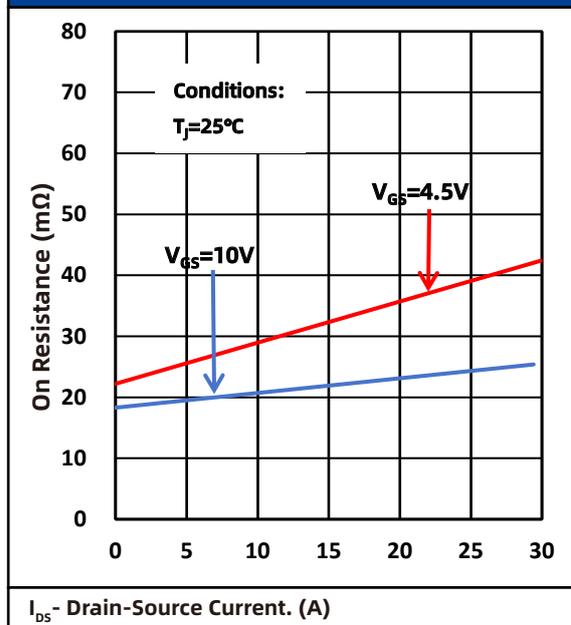
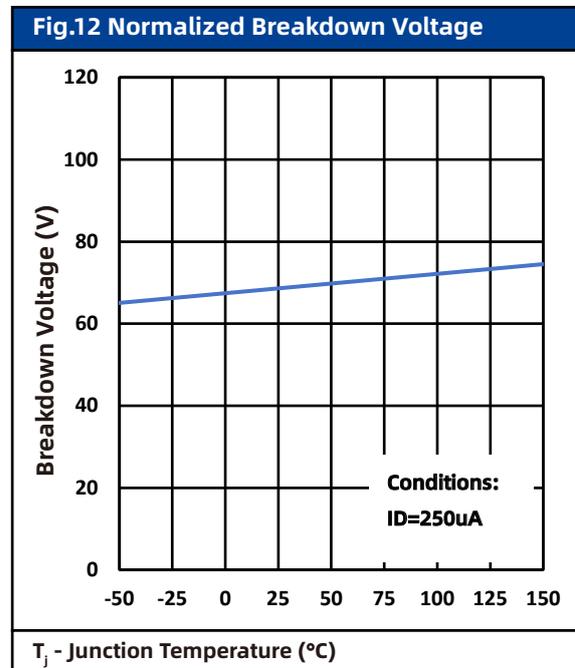
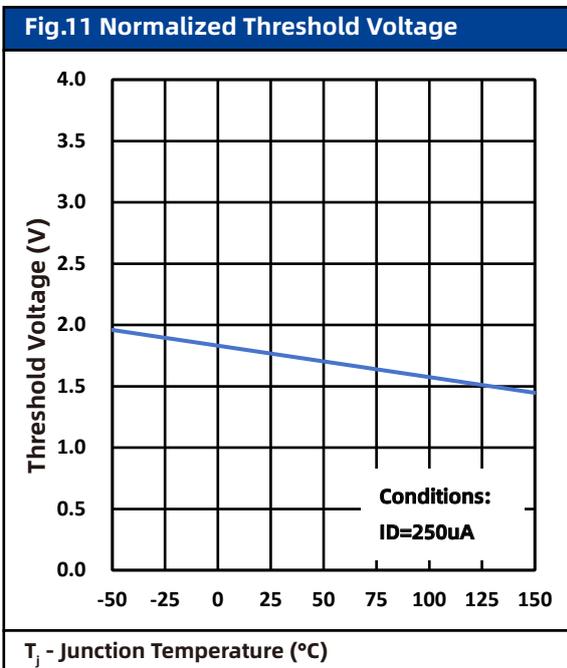
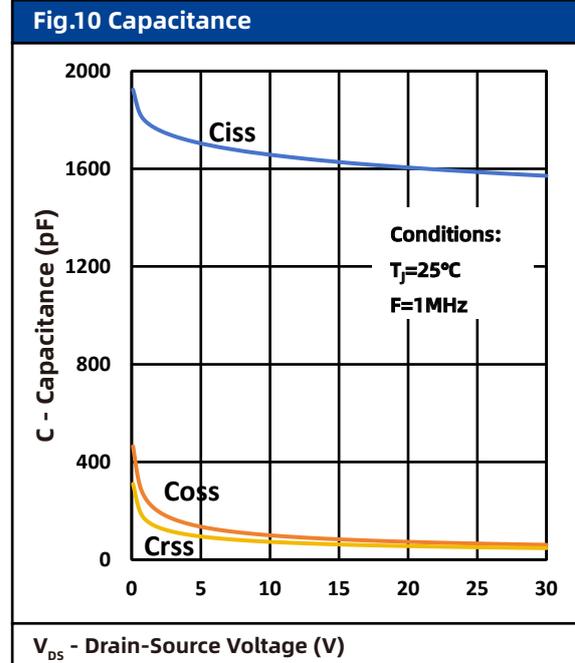
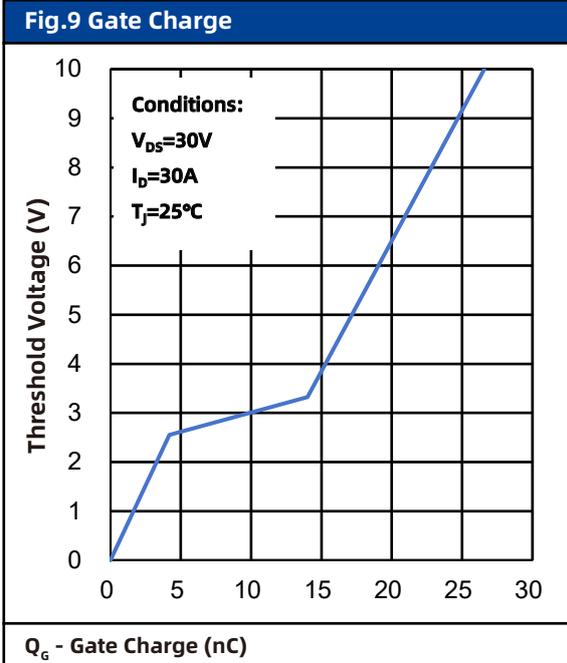


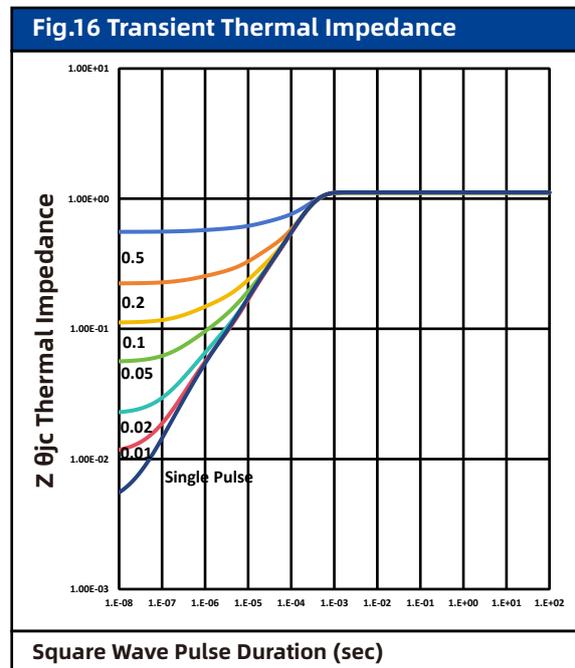
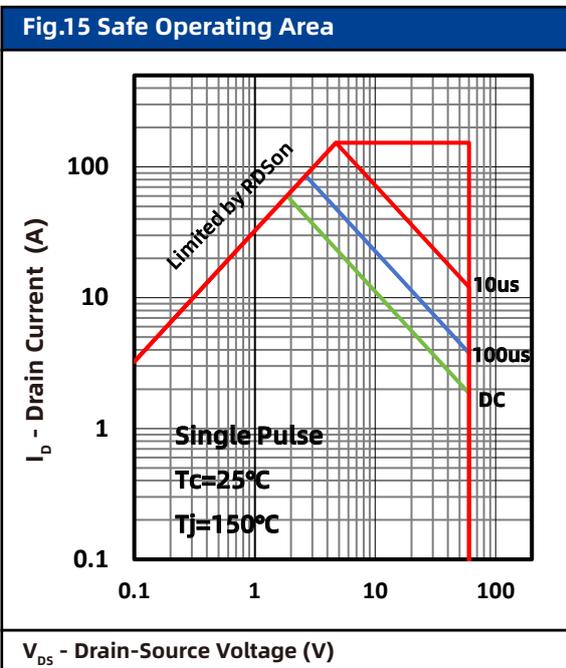
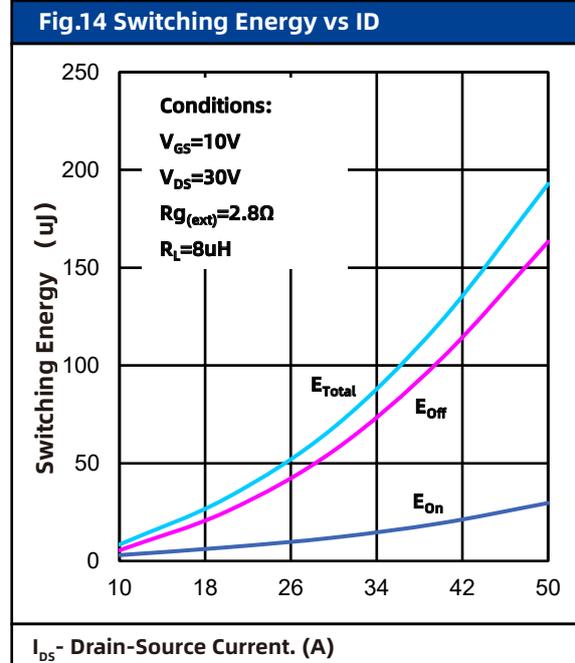
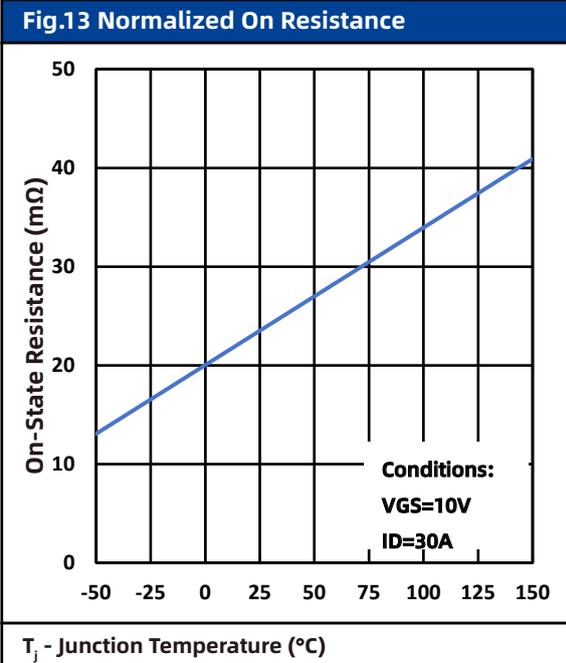
Fig.8 Drain-Source On Resistance



## 7. Typical Characteristics



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## 7. Typical Characteristics

Fig.17 Gate Charge Test Circuit & Waveform

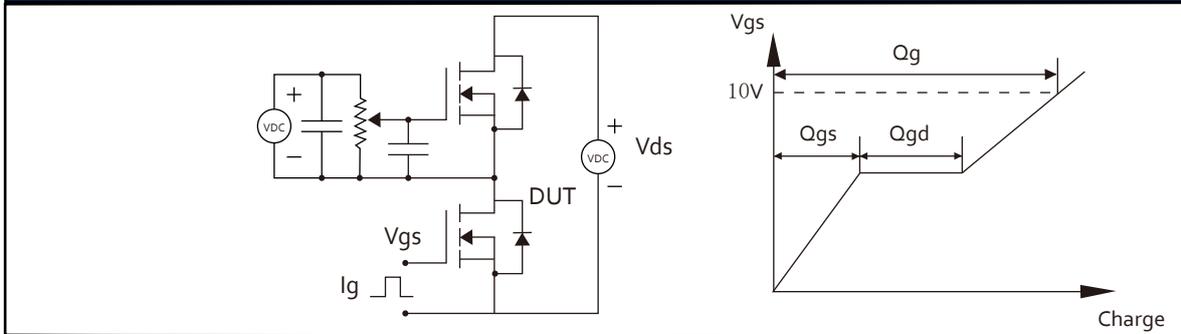


Fig.18 Resistive Switching Test Circuit & Waveforms



Fig.19 Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

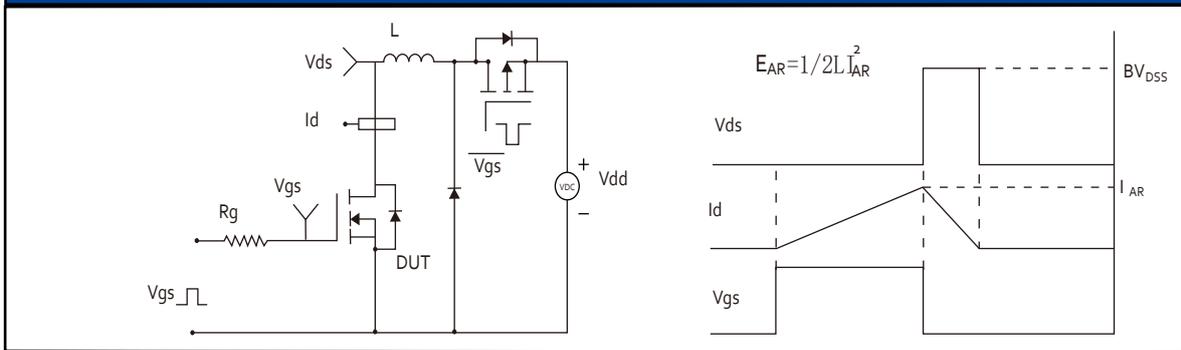
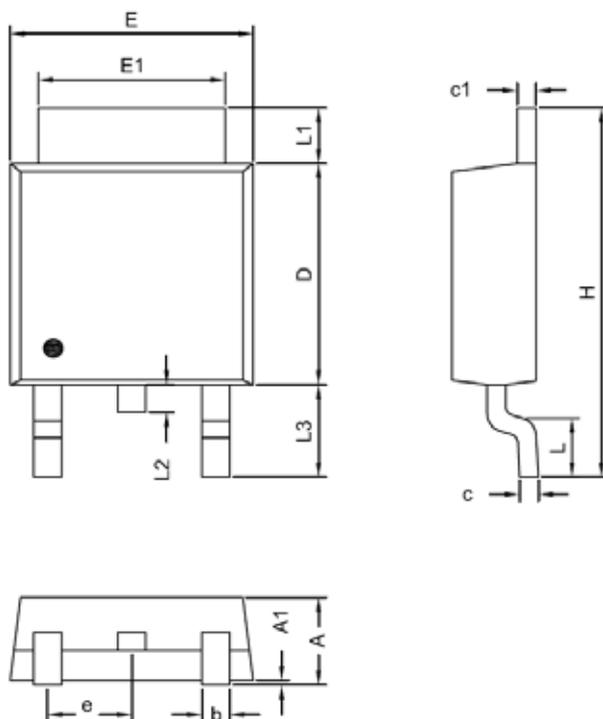


Fig.20 Diode Recovery Test Circuit & Waveforms



## 8. Package Dimensions

### T0252 Package



| Symbol | Unit : mm |        | Unit : inch |       |
|--------|-----------|--------|-------------|-------|
|        | MIN       | MAX    | MIN         | MAX   |
| A      | 2.080     | 2.500  | 0.082       | 0.098 |
| A1     | 0.000     | 0.250  | 0.000       | 0.010 |
| D      | 5.300     | 6.400  | 0.209       | 0.252 |
| E      | 6.100     | 6.850  | 0.240       | 0.270 |
| E1     | 4.676     | 5.650  | 0.184       | 0.222 |
| c      | 0.400     | 0.650  | 0.016       | 0.026 |
| c1     | 0.400     | 0.650  | 0.016       | 0.026 |
| b      | 0.500     | 1.000  | 0.020       | 0.039 |
| e      | 2.090     | 2.500  | 0.082       | 0.098 |
| L      | 1.000     | 1.800  | 0.039       | 0.071 |
| L1     | 0.700     | 1.800  | 0.028       | 0.071 |
| L2     | 0.500     | 1.200  | 0.020       | 0.047 |
| L3     | 2.400     | 3.070  | 0.094       | 0.121 |
| H      | 9.000     | 10.700 | 0.354       | 0.421 |

## 9. Record of Document amendment

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1.初版发行